



CMC Seminar – Shanghai Nov. 9
“Semiconductor Materials
Challenges In and Out of China”
for CMC Members, Fabs and the
Semiconductor Supply Chain

- ***Focused on the Developing Semiconductor Materials Supply Chain in China and Its impact on the World***

We look forward to seeing you there!

- **Seminar Location:**
- Holiday Inn Shanghai Pudong
899 Dong Fang Road, Pudong Shanghai 200122
P. R. China

For more details on Sponsorship please email
cmcinfo@techcet.com

CMC Seminar, Shanghai 2016

November 9, Holiday Inn Pudong, Shanghai



“Semiconductor Materials Challenges In and Out of China”

AGENDA	
8:30 AM	Registration – Opening Comments at 9:00 AM
9:05 AM	Keynote Presentation by Texas Instruments – Joel Strupp* <ul style="list-style-type: none">• Supply Chain Challenges for Fabs & Material Suppliers in China
9:35 AM	Intel Corporation F68 - Daniel Wu <ul style="list-style-type: none">• Semiconductor Material Challenges in China
10:05 AM	Lita Shon-Roy, President of TECHCET <ul style="list-style-type: none">• China’s Impact on the WW Materials Supply Chain
10:35 AM	Break – Sponsored by AUECC
10:50 AM	Ingrid Shi, Secretary General, ICMT* <ul style="list-style-type: none">• The China Materials Supply Consortium and China’s 5 Year Technology Plan
11:20 AM	Eric Xiong, Director, Industrial Chemical Sector, CIRS* <ul style="list-style-type: none">• China REACH and Associate Regulations
11:50 AM	Lunch – Sponsored by Cryoin
1:00 PM	Honggen Peng, Logistics Manager, Air Liquide* <ul style="list-style-type: none">• Logistics Supply Chain Challenges
1:30 PM	Jeff Jang, Product Quality Manager, Air Liquide <ul style="list-style-type: none">• Managing Supplier Quality in Asia/China
2:00 PM	John West, VLSI Research <ul style="list-style-type: none">• Equipment Consumables Components Company Perspective
2:30 PM	OPEN <ul style="list-style-type: none">• Open
3:00 PM	Break
3:15 PM	Mike Walden, Director & Sr. Market Analyst, TECHCET <ul style="list-style-type: none">• WW Silicon Wafer Market Status and Outlook
3:45 PM	Dr. Richard Chang, CEO, Zing (Shanghai New Semiconductor Technology, Ltd)* <ul style="list-style-type: none">• Status & Challenges of Building a 300mm Wafer Factory in China
4:15 PM	Panel Discussion* <ul style="list-style-type: none">• Logistics and Customs Constraints• Sustainability and Environmental Responsibility in China• China Government Funding for Non-Chinese Companies
5:00-7:00 PM	Reception (food & drink) – Co-Sponsored Event by Peric/718

For more info go to www.cmcfabs.org/seminars/ or contact msher@techcet.com, +1-480-382-8336 x1



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